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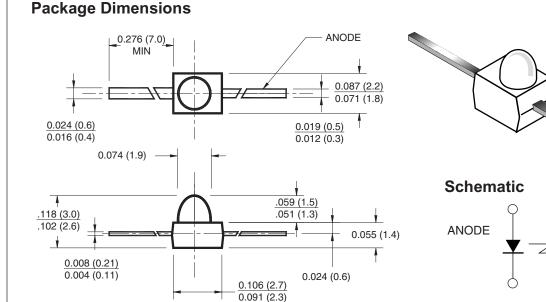
September 2006



QEB363 Subminiature Plastic Infrared Emitting Diode

Features

- T-3/4 (2mm) Surface Mount Package
- Tape & Reel Option (See Tape & Reel Specifications)
- Lead Form Options: Gullwing, Yoke, Z-Bend
- Narrow Emission Angle, 24°
- Wavelength = 940nm, GaAs
- Clear Water Lens
- Matched Photosensor: QSB363
- High Radiant Intensity



Notes:

- 1. Dimensions are in inches (mm).
- 2. Tolerance of ±.010 (.25) on all non nominal dimensions unless otherwise specified.

| Symbol | Parameter | Rating | Unit |
|--------------------|---|----------------|------|
| T _{OPR} | Operating Temperature | -40 to +100 | °C |
| T _{STG} | Storage Temperature | -40 to +100 | °C |
| T _{SOL-I} | Soldering Temperature (Iron) ^(2,3,4) | 240 for 5 sec | °C |
| T _{SOL-F} | Soldering Temperature (Flow) ^(2,3) | 260 for 10 sec | °C |
| ١ _F | Continuous Forward Current | 50 | mA |
| V _R | Reverse Voltage | 5 | V |
| PD | Power Dissipation ⁽¹⁾ | 100 | mW |

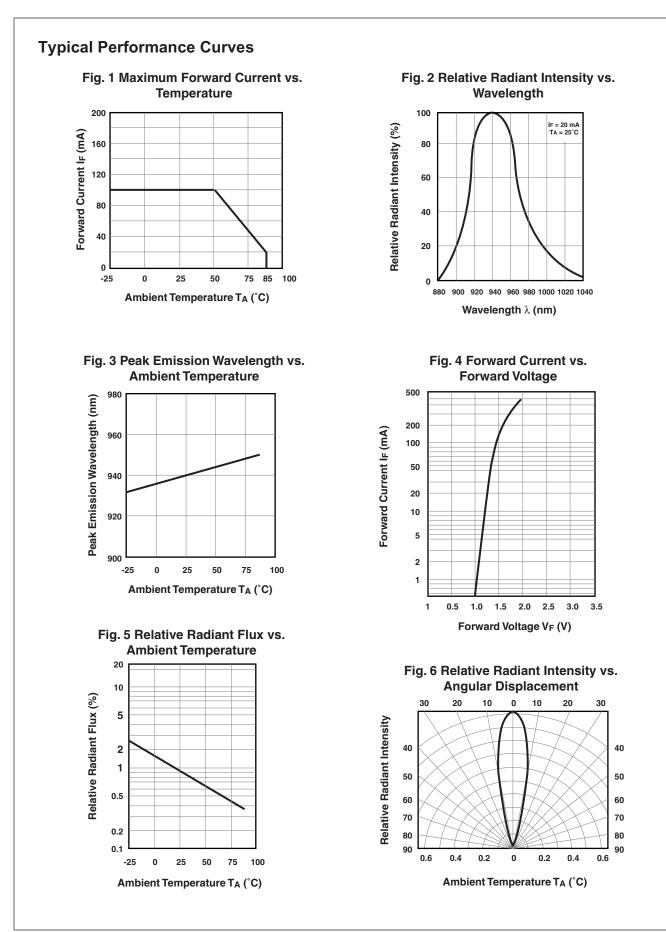
Absolute Maximum Ratings (T_A = 25°C unless otherwise specified)

Notes:

- 1. Derate power dissipation linearly 1.33mW/°C above 25°C.
- 2. RMA flux is recommended.
- 3. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 4. Soldering iron 1/16" (1.6mm) minimum from housing.

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Units |
|----------------|--------------------------|---|------|------|------|-------|
| λ _P | Peak Emission Wavelength | I _F = 100mA | | 940 | | nm |
| Θ | Emission Angle | I _F = 100mA | | ±12 | | 0 |
| V _F | Forward Voltage | I _F = 100mA, t _p = 20ms | | | 1.6 | V |
| I _R | Reverse Current | V _R = 5V | | | 100 | μA |
| Ι _e | Radiant Intensity | I _F = 100mA, tp = 20ms | 8 | | | mW/sr |
| t _r | Rise Time | I _F = 100mA | | 1 | | μs |
| t _f | Fall Time | t _p = 20ms | | 1 | | μs |

Electrical/Optical Characteristics (T_A = 25°C)

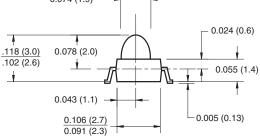


Surface Mount Options for T-3/4 Package

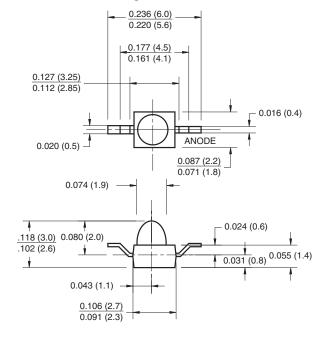
Features

- Three lead forming options: Gull Wing, Yoke and Z-Bend
- Compatible with automatic placement equipment
- Supplied on tape and reel or in bulk packaging
- Compatible with vapor phase reflow solder processes

Gull Wing Lead Configuration



Z-Bend Lead Configuration

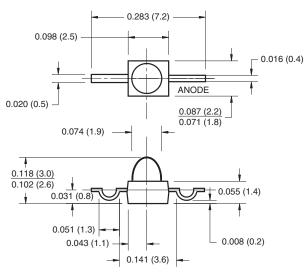


Notes: (Applies to all package drawings)

1. Dimensions are in inches (mm).

2. Tolerance of ±.010 (.25) on all non nominal dimensions unless otherwise specified.

Yoke Lead Configuration



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QEB363 Subminiature Plastic Infrared Emitting Diode

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